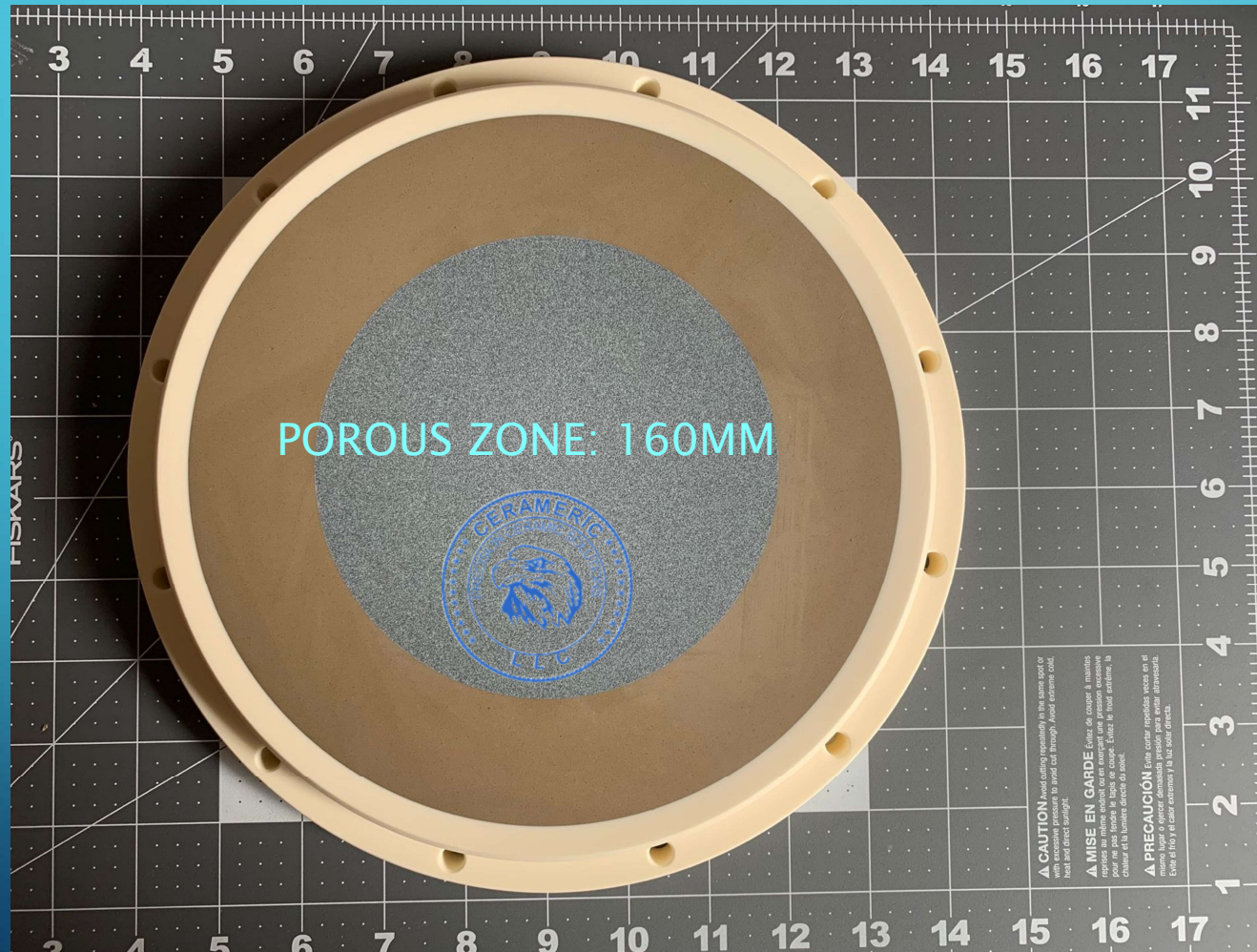


DISCO DAG810 WAFER GRINDING CHUCK MODIFICATION



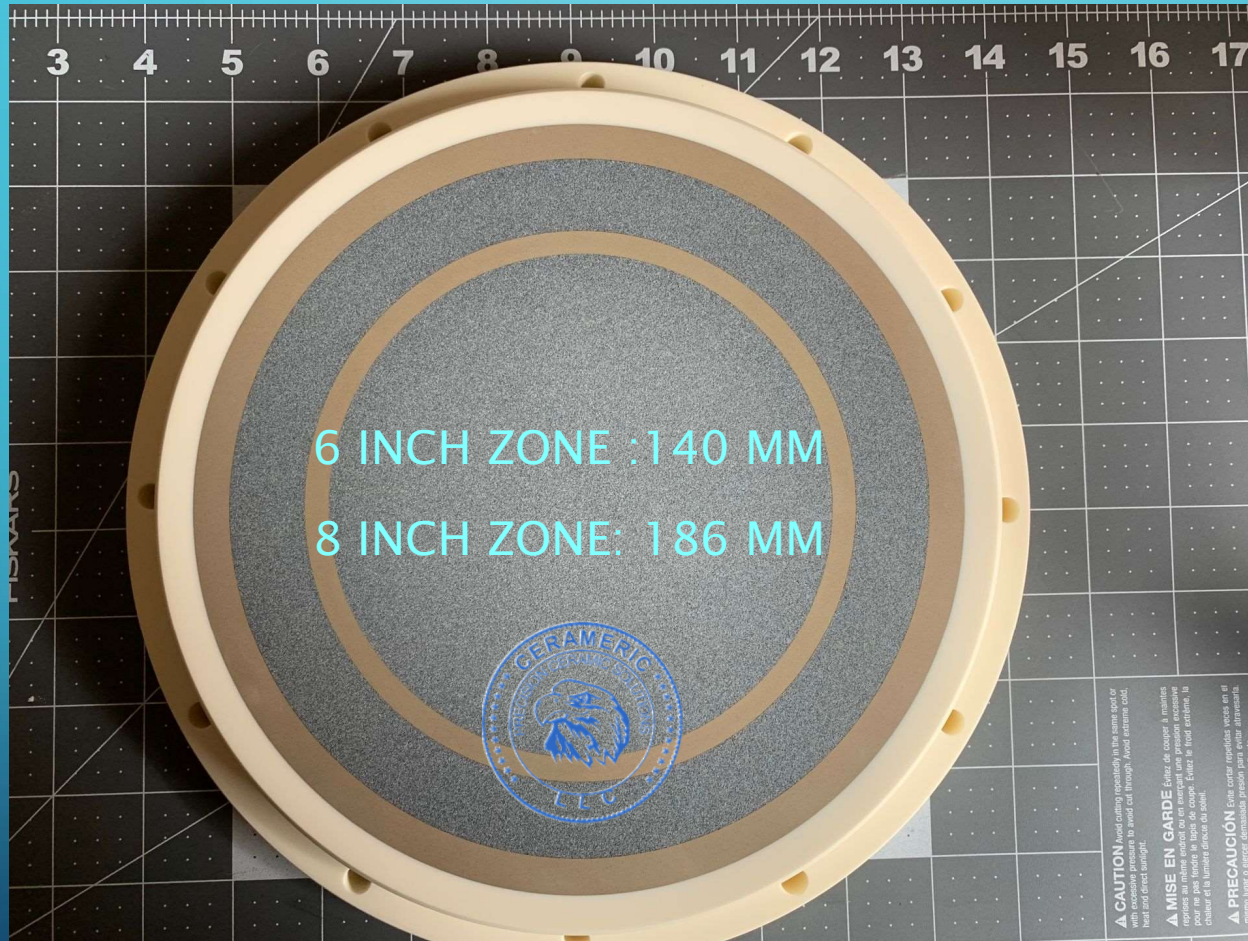
DISCO DAG810 WAFER GRINDING CHUCK MODIFICATION



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